

MITSUBISHI IGBT MODULES
CM600HU-12F

HIGH POWER SWITCHING USE

CM600HU-12F



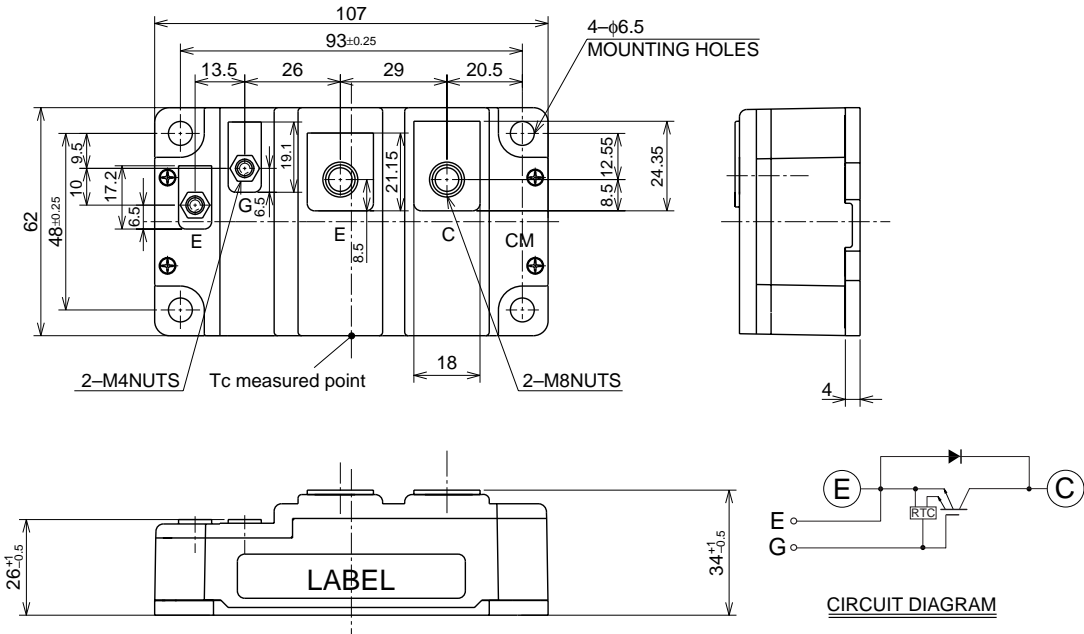
- Ic 600A
- VCES 600V
- Insulated Type
- 1-elements in a pack

APPLICATION

General purpose inverters & Servo controls, etc

OUTLINE DRAWING & CIRCUIT DIAGRAM

Dimensions in mm



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MAXIMUM RATINGS (T_j = 25°C)

Symbol	Parameter	Conditions	Ratings	Unit
V _{CES}	Collector-emitter voltage	G-E Short	600	V
V _{GES}	Gate-emitter voltage	C-E Short	±20	V
I _C	Collector current	T _C = 25°C	600	A
I _{CM}		Pulse (Note 2)	1200	
I _E (Note 1)	Emitter current	T _C = 25°C	600	A
I _{EM} (Note 1)		Pulse (Note 2)	1200	
P _C (Note 3)	Maximum collector dissipation	T _C = 25°C	1420	W
T _j	Junction temperature		-40 ~ +150	°C
T _{stg}	Storage temperature		-40 ~ +125	°C
V _{iso}	Isolation voltage	Main terminal to base plate, AC 1 min.	2500	V
—	Torque strength	Main Terminal M8	8.8 ~ 10.8	N • m
		Mounting holes M6	3.5 ~ 4.5	N • m
		G(E) Terminal M4	1.3 ~ 1.7	N • m
—	Weight	Typical value	450	g

ELECTRICAL CHARACTERISTICS (T_j = 25°C)

Symbol	Parameter	Test conditions	Limits			Unit	
			Min.	Typ.	Max.		
I _{CES}	Collector cutoff current	V _{CE} = V _{CES} , V _{GE} = 0V	—	—	1	mA	
V _{GE(th)}	Gate-emitter threshold voltage	I _C = 60mA, V _{CE} = 10V	5	6	7	V	
I _{GES}	Gate leakage current	V _{GE} = V _{CES} , V _{CE} = 0V	—	—	80	μA	
V _{CE(sat)}	Collector-emitter saturation voltage	T _j = 25°C	—	1.6	2.2	V	
		T _j = 125°C		1.6	—		
C _{ies}	Input capacitance	V _{CE} = 10V V _{GE} = 0V	—	—	160	nF	
C _{oes}	Output capacitance		—	—	11		
C _{res}	Reverse transfer capacitance		—	—	6.0		
Q _G	Total gate charge	V _{CC} = 300V, I _C = 600A, V _{GE} = 15V	—	3720	—	nC	
t _{d(on)}	Turn-on delay time	V _{CC} = 300V, I _C = 600A V _{GE1} = V _{GE2} = 15V R _G = 3.1Ω, Inductive load switching operation I _E = 600A	—	—	600	ns	
t _r	Turn-on rise time		—	—	400		
t _{d(off)}	Turn-off delay time		—	—	900		
t _f	Turn-off fall time		—	—	250		
t _{rr} (Note 1)	Reverse recovery time		—	—	300		
Q _{rr} (Note 1)	Reverse recovery charge		—	11.7	—		μC
V _{EC} (Note 1)	Emitter-collector voltage		I _E = 600A, V _{GE} = 0V	—	—		2.6
R _{th(j-c)Q}	Thermal resistance ^{*1}	IGBT part	—	—	0.088	°C/W	
R _{th(j-c)R}		FWDi part	—	—	0.12		
R _{th(c-f)}	Contact thermal resistance	Case to fin, Thermal compound applied ^{*2}	—	0.02	—		
R _{th(j-c)Q}	Thermal resistance	T _C measured point is just under the chips	—	—	0.048 ^{*3}		
R _G	External gate resistance		3.1	—	31	Ω	

Note 1. I_E, V_{EC}, t_{rr}, Q_{rr}, die/dt represent characteristics of the anti-parallel, emitter to collector free-wheel diode. (FWDi).

2. Pulse width and repetition rate should be such that the device junction temp. (T_j) does not exceed T_{jmax} rating.

3. Junction temperature (T_j) should not increase beyond 150°C.

4. Pulse width and repetition rate should be such as to cause negligible temperature rise.

*1 : T_C measured point is indicated in OUTLINE DRAWING.

*2 : Typical value is measured by using Shin-etsu Silicone "G-746".

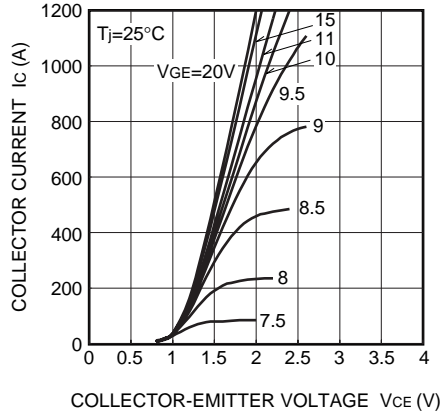
*3 : If you use this value, R_{th(f-a)} should be measured just under the chips.

CM600HU-12F

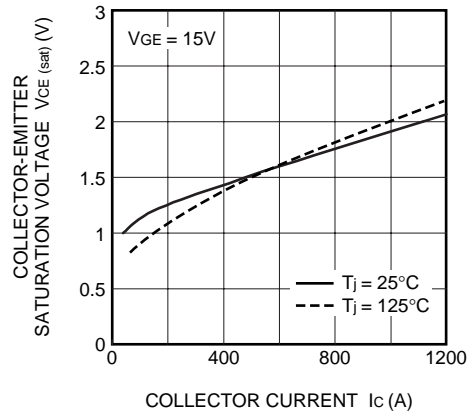
HIGH POWER SWITCHING USE

PERFORMANCE CURVES

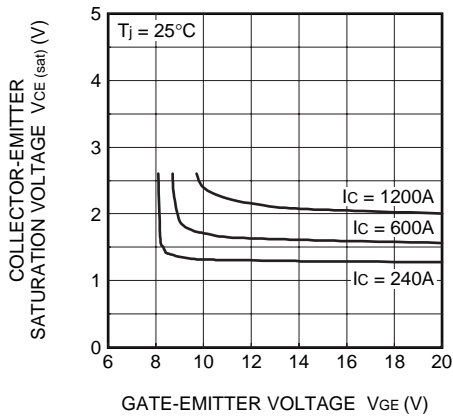
OUTPUT CHARACTERISTICS (TYPICAL)



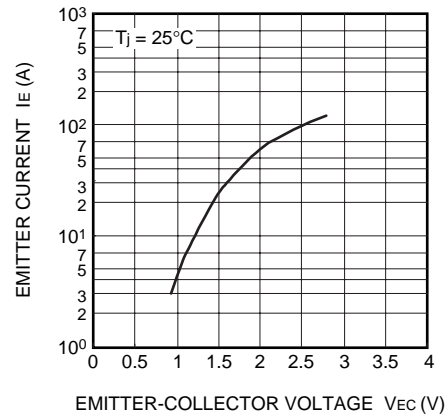
COLLECTOR-EMITTER SATURATION VOLTAGE CHARACTERISTICS (TYPICAL)



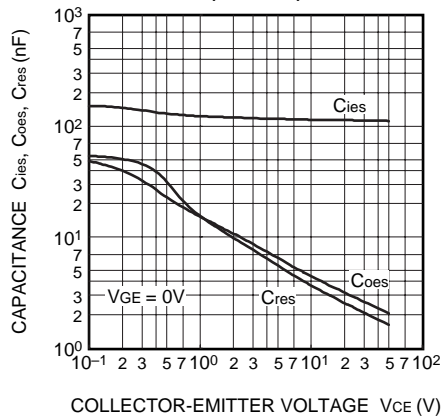
COLLECTOR-EMITTER SATURATION VOLTAGE CHARACTERISTICS (TYPICAL)



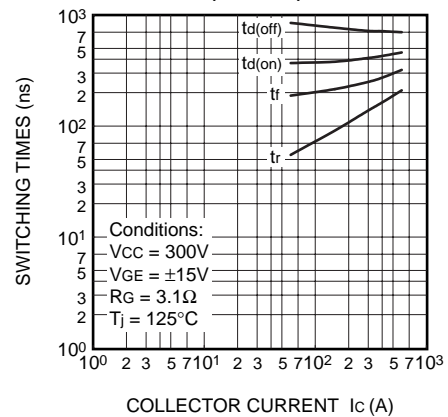
FREE-WHEEL DIODE FORWARD CHARACTERISTICS (TYPICAL)



CAPACITANCE- V_{CE} CHARACTERISTICS (TYPICAL)



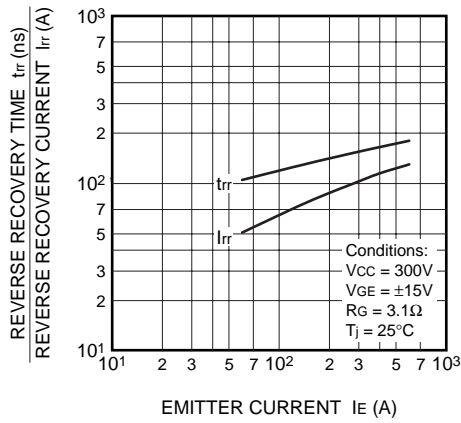
HALF-BRIDGE SWITCHING CHARACTERISTICS (TYPICAL)



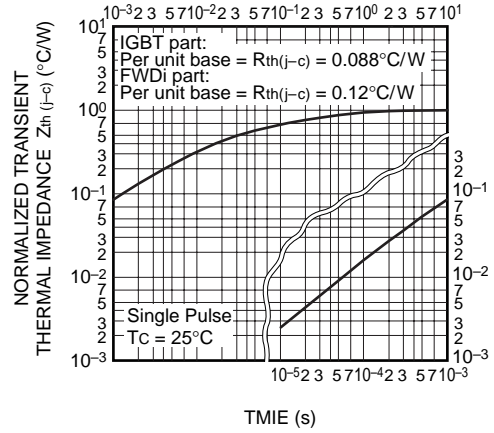
CM600HU-12F

HIGH POWER SWITCHING USE

REVERSE RECOVERY CHARACTERISTICS OF FREE-WHEEL DIODE (TYPICAL)



TRANSIENT THERMAL IMPEDANCE CHARACTERISTICS (IGBT part & FWDi part)



GATE CHARGE CHARACTERISTICS (TYPICAL)

